

# MA4AGBLP912

## AlGaAs Beamlead PIN Diode

V3

### Features

- ◆ Low Series Resistance
- ◆ Low Capacitance
- ◆ Millimeter Wave Switching
- ◆ Millimeter Wave Cutoff Frequency
- ◆ 5 Nanosecond Switching Speed
- ◆ Can be Driven by a Buffered +5V TTL
- ◆ Silicon Nitride Passivation
- ◆ Polyimide Scratch Protection
- ◆ RoHS Compliant

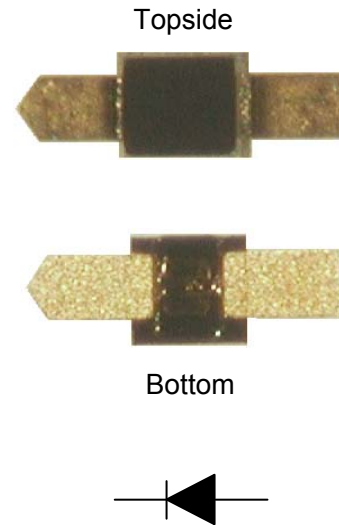
### Description

M/A-COM Technology Solutions MA4AGBLP912 is an Aluminum-Gallium-Arsenide anode enhanced, beam lead PIN diode. AlGaAs anodes, which utilize M/A-COM Tech's patent pending hetero-junction technology, produce less diode "On" resistance than a conventional GaAs device. This device is fabricated on a OMCVD epitaxial wafer using a process optimized for high device uniformity and extremely low parasitics. The diode exhibits low series resistance, 4Ω, low capacitance, 28fF, and an extremely fast switching speed of 5nS. It is fully passivated with silicon nitride and has an additional polymer layer for scratch protection. The protective coating prevents damage to the junction and the anode air bridges during handling and assembly.

### Applications

The ultra low capacitance of the MA4AGBLP912 device makes it ideally suited for use through W-band. The low RC product and low profile of the beamlead PIN diode allows for use in microwave and millimeter wave switch designs, where low insertion loss and high isolation are required. The operating bias conditions of +10mA for the low loss state, and 0V, for the isolation state permits the use of a simple +5V TTL gate driver. AlGaAs, beamlead diodes, can be used in switching arrays on radar systems, high speed ECM circuits, optical switching networks, instrumentation, and other wideband multi-throw switch assemblies.

### MA4AGBLP912

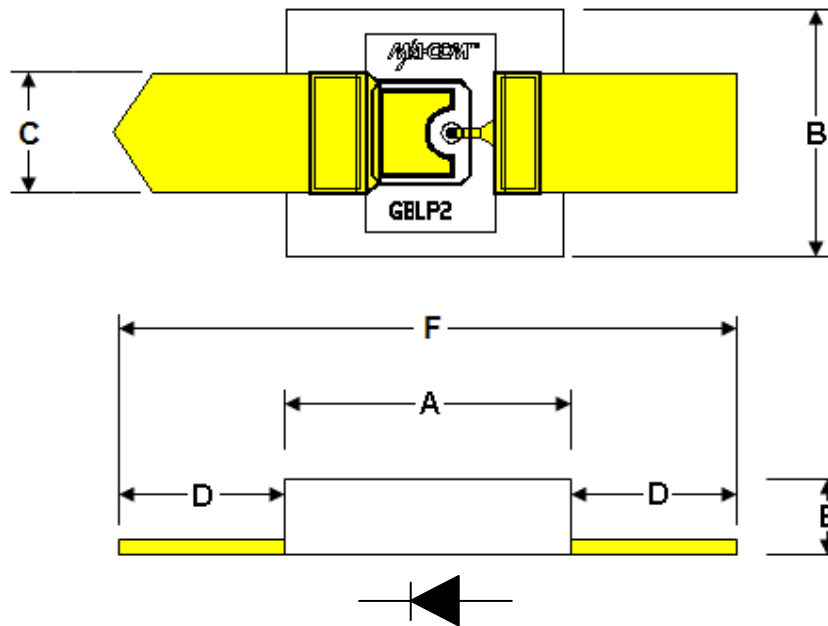


### Absolute Maximum Ratings @ T<sub>AMB</sub> = 25°C (unless otherwise specified)

| Parameter             | Absolute Maximum      |
|-----------------------|-----------------------|
| Reverse Voltage       | -50V                  |
| Operating Temperature | -65°C to +125°C       |
| Storage Temperature   | -65°C to +150°C       |
| Junction Temperature  | +175°C                |
| Forward DC Current    | 40mA                  |
| C.W. Incident Power   | +23dBm                |
| Mounting Temperature  | +235°C for 10 seconds |

### Electrical Specifications at $T_{AMB} = 25^{\circ}C$

| Test Conditions                  | Parameters | Units | Min | Typical | Max. |
|----------------------------------|------------|-------|-----|---------|------|
| Total Capacitance @ -5V/1 MHz    | Ct         | fF    | -   | 26      | 30   |
| Forward Resistance @ +20mA/1 GHz | Rs         | Ohms  | -   | 4       | 4.9  |
| Forward Voltage at +10mA         | Vf         | Volts | 1.2 | 1.36    | 1.5  |
| Leakage Current at -40 V         | Ir         | nA    | -   | 50      | 300  |
| Minority Carrier Lifetime        | TL         | nS    | -   | 5       | 10   |



| DIM | INCHES |        | MM     |         |
|-----|--------|--------|--------|---------|
|     | MIN.   | MAX.   | MIN.   | MAX.    |
| A   | 0.009  | 0.013  | 0.2286 | 0.3302  |
| B   | 0.0049 | 0.0089 | 0.1245 | 0.2261  |
| C   | 0.0037 | 0.0057 | 0.0940 | 0.1448  |
| D   | 0.0049 | 0.0089 | 0.1245 | 0.2261  |
| E   | 0.002  | 0.006  | 0.0508 | 0.1524  |
| F   | 0.0218 | 0.0278 | 0.5537 | 0.70612 |

**ADVANCED:** Data Sheets contain information regarding a product M/A-COM is considering for development. Performance is based on target specifications, simulated results, and/or prototype measurements. Commitment to develop is not guaranteed.

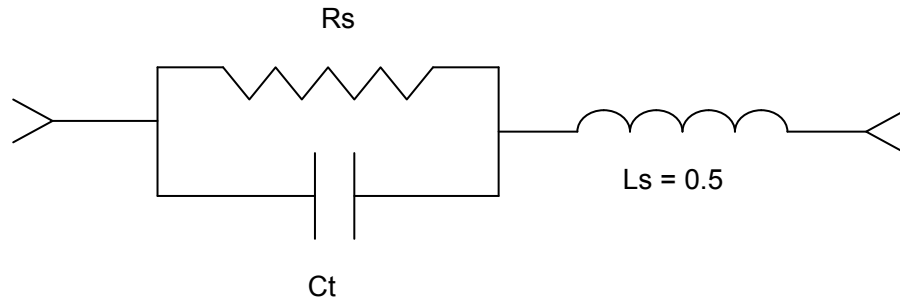
**PRELIMINARY:** Data Sheets contain information regarding a product M/A-COM has under development. Performance is based on engineering tests. Specifications are typical. Mechanical outline has been fixed. Engineering samples and/or test data may be available. Commitment to produce in volume is not guaranteed.

• **North America** Tel: 800.366.2266 / Fax: 978.366.2266  
 • **Europe** Tel: 44.1908.574.200 / Fax: 44.1908.574.300  
 • **Asia/Pacific** Tel: 81.44.844.8296 / Fax: 81.44.844.8298

Visit [www.macom.com](http://www.macom.com) for additional data sheets and product information.

M/A-COM Inc. and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice.

### Diode Model



### MA4AGBLP912 SPICE Model

$I_s = 1.0E-14$  A  
 $V_i = 0.0$  V                       $wBv = 50$  V  
 $\mu_e = 8600$  cm<sup>2</sup>/V-sec       $wPmax = 100$  mW  
 $W_i = 3.0$   $\mu$ m                       $Ffe = 1.0$   
 $R_r = 10$  K Ohms  
 $C_{jmin} = 0.020$  pF  
 $\tau = 10$  nsec  
 $R_s(I) = R_c + R_j(I) = 0.10$  Ohm +  $R_j(I)$   
 $C_{j0} = 0.022$  pF  
 $V_j = 1.35$  V  
 $M = 0.5$   
 $F_c = 0.5$   
 $I_{max} = 0.04$  A  
 $K_f = 0.0$   
 $A_f = 1.0$

## Handling and Assembly Procedures

*The following precautions should be observed to avoid damaging these devices.*

### **Cleanliness**

These devices should be handled in a clean environment.

### **Static Sensitivity**

Aluminum Gallium Arsenide PIN diodes are Class 1 ESD sensitive and can be damaged by static electricity. Proper ESD techniques should be used when handling these devices.

### **General Handling**

These devices have a polymer layer which provides scratch protection for the junction area and the anode air bridge. Beam lead devices must, however, be handled with extreme care since the leads may easily be distorted or broken by the normal pressures exerted when handled with tweezers. A vacuum pencil with a #27 tip is recommended for picking and placing.

### **Attachment**

These devices were designed to be inserted onto hard or soft substrates. Recommended methods of attachment include thermo-compression bonding, parallel-gap welding and electrically conductive silver epoxy.

## Ordering Information

| Part Number | Packaging |
|-------------|-----------|
| MA4AGBLP912 | Gel Pak   |

## Данный компонент на территории Российской Федерации

### Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9